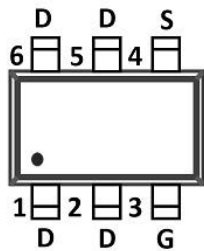
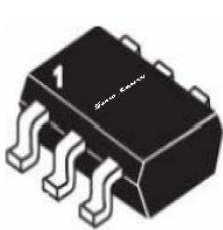
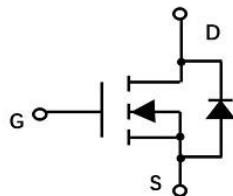


N-Channel Enhancement Mode Field Effect Transistor



SOT-23-6L



Product Summary

- V_{DS} 110V
- I_D 3A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) <140 mohm
- $R_{DS(ON)}$ (at $V_{GS}=4.5V$) <250 mohm

General Description

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$

Applications

- DC-DC Converters
- Power management functions

■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	110	V
Gate-source Voltage		V_{GS}	± 20	V
Drain Current	$T_A=25^\circ\text{C}$	I_D	3	A
	$T_A=70^\circ\text{C}$		2.4	
Pulsed Drain Current ^A		I_{DM}	12	A
Avalanche energy ^B		E_{AS}	8	mJ
Total Power Dissipation ^C	$T_A=25^\circ\text{C}$	P_D	1.5	W
	$T_A=70^\circ\text{C}$		1.0	
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	$^\circ\text{C}$

■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient ^D	$t \leq 10\text{S}$	$R_{\theta JA}$	65	80	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Ambient ^{D E}	Steady-State		85	100	
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JL}$	43	52	

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SCJ03G10A	F2	G1003	3000	30000	120000	7"Reel

SCJ03G10A

■ Electrical Characteristics (T_j=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA	110			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =110,V _{GS} =0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	1.2	1.8	2.8	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D =3A		110	140	mΩ
		V _{GS} = 4.5V, I _D =2A		135	250	mΩ
Diode Forward Voltage	V _{SD}	I _S =3A,V _{GS} =0V			1.3	V
Maximum Body-Diode Continuous Current	I _S				3	A
Gate resistance	R _G	f= 1 MHz, Open drain		8		Ω
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =50V,V _{GS} =0V,f=100KHZ		206		pF
Output Capacitance	C _{oss}			28.9		
Reverse Transfer Capacitance	C _{rss}			1.4		
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =10V,V _{DS} =50V,I _D =3A		4.3		nC
Gate-Source Charge	Q _{gs}			1.5		
Gate-Drain Charge	Q _{gd}			1.1		
Reverse Recovery Chrage	Q _{rr}	I _F =3A, di/dt=100A/us		39.4		ns
Reverse Recovery Time	t _{rr}			32.1		
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DD} =50V,I _D =3A R _{GEN} =2Ω		14.7		
Turn-on Rise Time	t _r			3.5		
Turn-off Delay Time	t _{D(off)}			20.9		
Turn-off fall Time	t _f			2.7		

A. Repetitive rating; pulse width limited by max. junction temperature.

B. V_{DD}=50V, R_G=25Ω, L=0.5mH.

C. Pd is based on max. junction temperature, using ≤10us junction-to-ambient thermal resistance.

D. The value of R_{θJA} is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design.

E. The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient

■ Typical Performance Characteristics

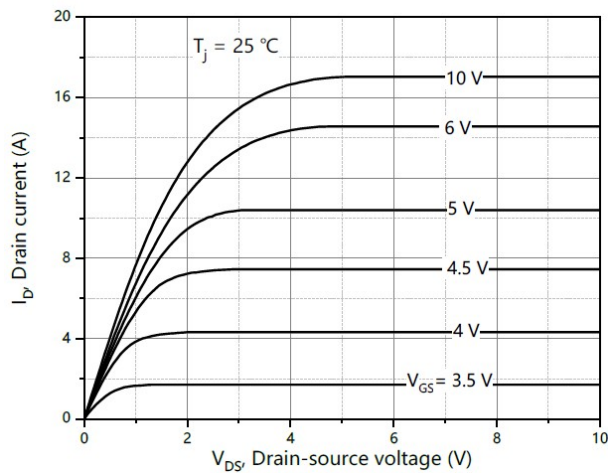


Figure1. Output Characteristics

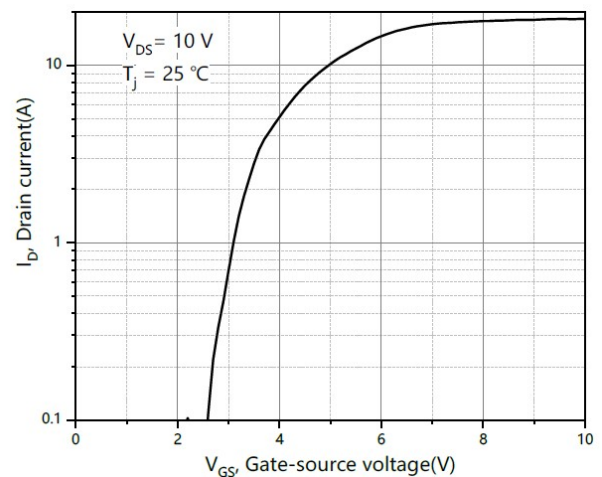


Figure2. Transfer Characteristics

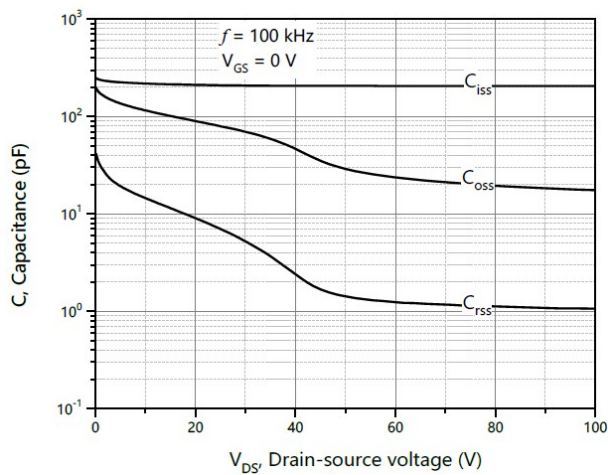


Figure3. Capacitance Characteristics

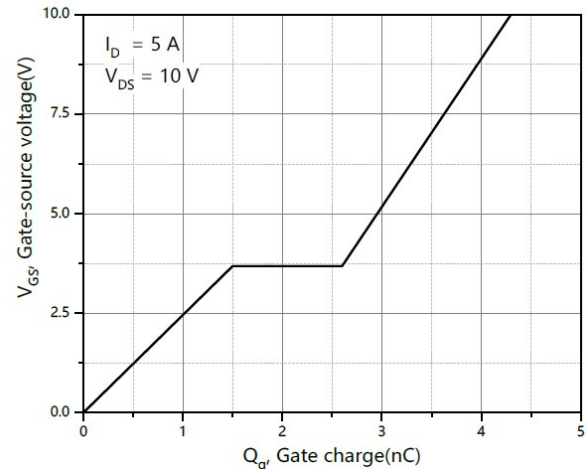


Figure4. Gate Charge

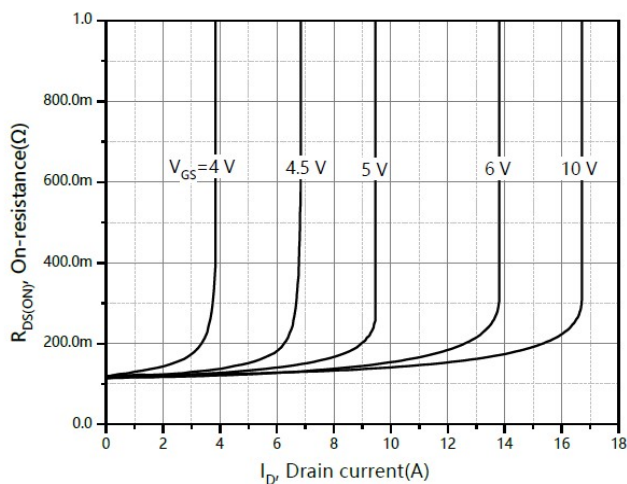


Figure5. : On-Resistance vs. Drain Current and Gate Voltage

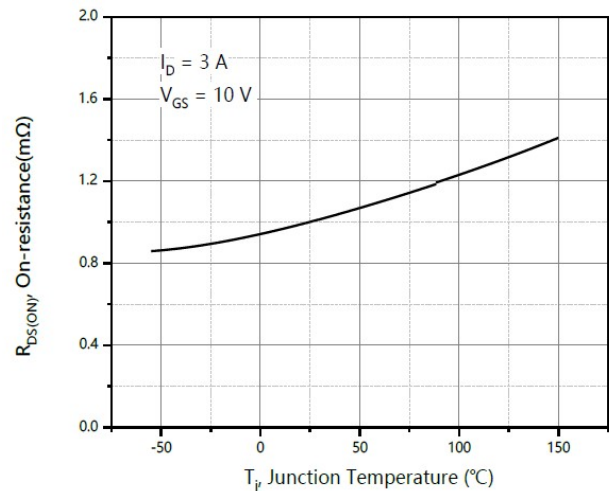
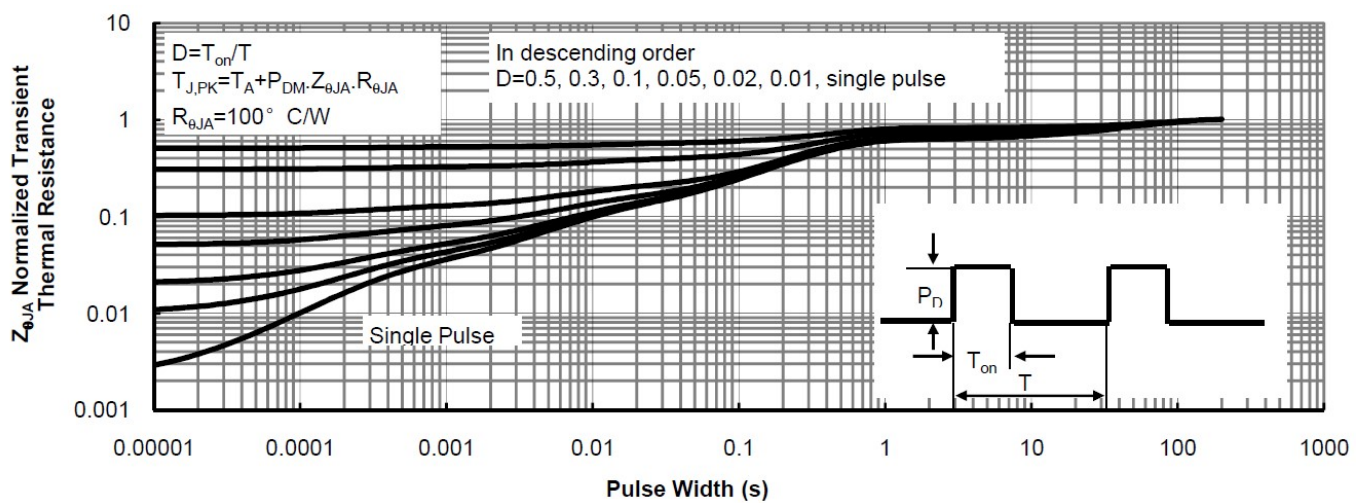
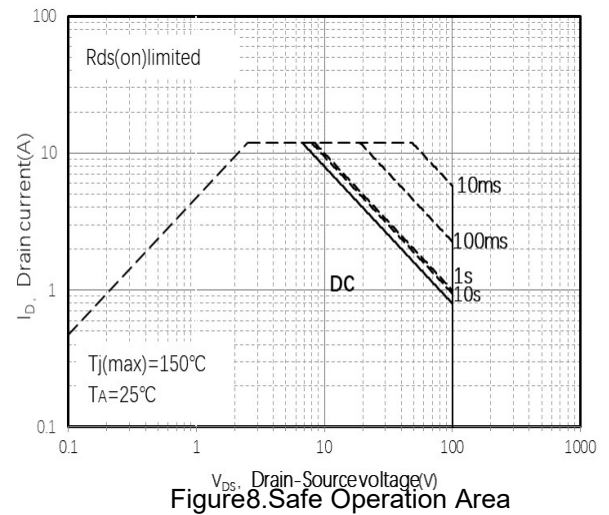
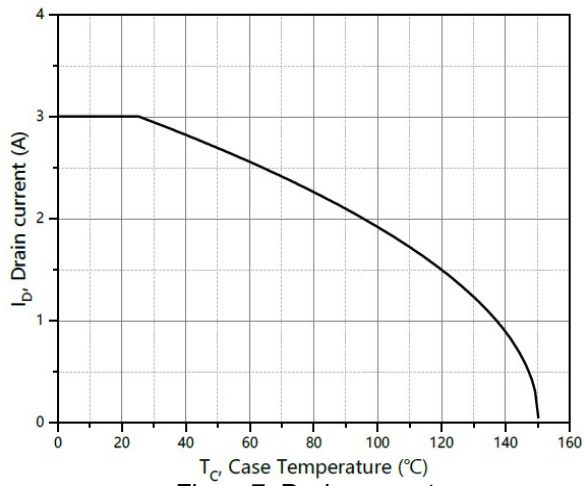
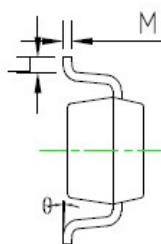
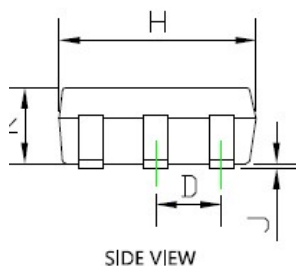
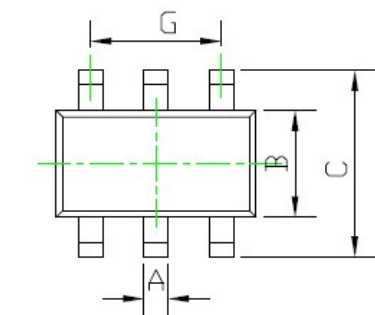


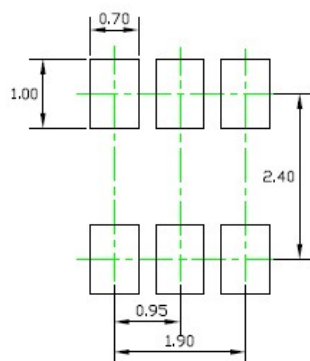
Figure6. Normalized On-Resistance



■ SOT-23-6L Package information



SIDE VIEW



Suggested Solder Pad Layout

Note:
 1. Controlling dimension in millimeters,
 2. General tolerance: $\pm 0.05\text{mm}$,
 3. The pad layout is for reference purposes only.

SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.012	0.020	0.300	0.500
B	0.059	0.067	1.500	1.700
C	0.104	0.116	2.650	2.950
D	0.037BSC		0.950BSC	
G	0.075BSC		1.900BSC	
H	0.111	0.119	2.820	3.020
J	0.000	0.004	0.000	0.100
K	0.041	0.045	1.050	1.150
L	0.012	0.024	0.300	0.600
M	0.004	0.008	0.100	0.200
θ	0°	8°	0°	8°

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